

## • General Description

The AGM615MNA combines advanced trench MOSFET technology with a low resistance package to provide extremely low  $R_{DS(ON)}$ .

This device is ideal for load switch and battery protection applications.

## Product Summary

| BVDSS | RDS(on) | ID  |
|-------|---------|-----|
| 60V   | 10mΩ    | 53A |

## PDFN5\*6 Pin Configuration

## • Features

- Advance high cell density Trench technology
- Low  $R_{DS(ON)}$  to minimize conductive loss
- Low Gate Charge for fast switching
- Low Thermal resistance
- 100% Avalanche tested
- 100% DVDS tested

## • Application

- MB/VGA Vcore
- SMPS 2<sup>nd</sup> Synchronous Rectifier
- POL application
- BLDC Motor driver

## Package Marking and Ordering Information

| Device Marking | Device    | Device Package | Reel Size | Tape width | Quantity |
|----------------|-----------|----------------|-----------|------------|----------|
| AGM615MNA      | AGM615MNA | PDFN5*6        | 330mm     | 12mm       | 3000     |

**Table 1. Absolute Maximum Ratings (TA=25°C)**

| Symbol      | Parameter   | Value      | Unit |
|-------------|---|------------|------|
| VDS         | Drain-Source Voltage (VGS=0V)                     | 60         | V    |
| VGS         | Gate-Source Voltage (VDS=0V)                      | ±20        | V    |
| ID          | Drain Current-Continuous(Tc=25°C) <b>(Note 1)</b> | 53         | A    |
|             | Drain Current-Continuous(Tc=100°C)                | 36         | A    |
| IDM (pulse) | Drain Current-Pulsed <b>(Note 2)</b>              | 212        | A    |
| PD          | Maximum Power Dissipation(Tc=25°C)                | 78         | W    |
|             | Maximum Power Dissipation(Tc=100°C)               | 31         | W    |
| EAS         | Avalanche energy <b>(Note 3)</b>                  | 100        | mJ   |
| TJ,TSTG     | Operating Junction and Storage Temperature Range  | -55 To 150 | °C   |

**Table 2. Thermal Characteristic**

| Symbol           | Parameter   | Typ | Max | Unit |
|------------------|---|-----|-----|------|
| R <sub>θJA</sub> | Thermal Resistance Junction-ambient (Steady State) <sup>1</sup> | --- | 60  | °C/W |
| R <sub>θJC</sub> | Thermal Resistance Junction-Case <sup>1</sup>                   | --- | 1.6 | °C/W |

**Table 3. Electrical Characteristics (TJ=25°C unless otherwise noted)**

| <b>Symbol</b>                             | <b>Parameter</b>                 | <b>Conditions</b>                    | <b>Min</b> | <b>Typ</b> | <b>Max</b> | <b>Unit</b> |
|---|----------------------------------|--------------------------------------|------------|------------|------------|-------------|
| <b>On/Off States</b>                      |                                  |                                      |            |            |            |             |
| BVDSS                                     | Drain-Source Breakdown Voltage   | VGS=0V ID=250µA                      | 60         | --         | --         | V           |
| IDSS                                      | Zero Gate Voltage Drain Current  | VDS=48V, VGS=0V                      | --         | --         | 1.0        | µA          |
| IGSS                                      | Gate-Body Leakage Current        | VGS=±20V, VDS=0V                     | --         | --         | ±100       | nA          |
| VGS(th)                                   | Gate Threshold Voltage           | VDS=VGS, ID=250µA                    | 1.2        | --         | 2.2        | V           |
| gFS                                       | Forward Transconductance         | VDS=5V, ID=10A                       | --         | 22         | --         | S           |
| RDS(on)                                   | Drain-Source On-State Resistance | VGS=10V, ID=20A                      | --         | 10         | 16         | mΩ          |
|   |                                  | VGS=4.5V, ID=10A                     | --         | 14         | 19         | mΩ          |
| <b>Dynamic Characteristics</b>            |                                  |                                      |            |            |            |             |
| Ciss                                      | Input Capacitance                | VDS=30V, VGS=0V,<br>F=100 kHz        | --         | 1528       | --         | pF          |
| Coss                                      | Output Capacitance               |                                      | --         | 78         | --         | pF          |
| Crss                                      | Reverse Transfer Capacitance     |                                      | --         | 71         | --         | pF          |
| Rg  | Gate resistance                  | VGS=0V,<br>VDS=0V, f=1.0MHz          | --         | 1.7        | --         | Ω           |
| <b>Switching Times</b>                    |                                  |                                      |            |            |            |             |
| td(on)                                    | Turn-on Delay Time               | VGS=10V, VDS=30V<br>RI=1.5Ω, RGEN=3Ω | --         | 7.1        | --         | nS          |
| tr  | Turn-on Rise Time                |                                      | --         | 5.1        | --         | nS          |
| td(off)                                   | Turn-Off Delay Time              |                                      | --         | 26.3       | --         | nS          |
| tf  | Turn-Off Fall Time               |                                      | --         | 5.5        | --         | nS          |
| Qg  | Total Gate Charge                | VGS=10V, VDS=30V,<br>ID=30A          | --         | 45.2       | --         | nC          |
| Qgs                                       | Gate-Source Charge               |                                      | --         | 6.0        | --         | nC          |
| Qgd                                       | Gate-Drain Charge                |                                      | --         | 14.1       | --         | nC          |
| <b>Source-Drain Diode Characteristics</b> |                                  |                                      |            |            |            |             |
| ISD                                       | Source-Drain Current(Body Diode) |                                      | --         | --         | 53         | A           |
| VSD                                       | Forward on Voltage               | VGS=0V, IS=20A                       | --         | --         | 1.2        | V           |
| trr                                       | Reverse Recovery Time            | Is=20A , dl/dt=100A/µs ,<br>TJ=25°C  | --         | 29         | --         | ns          |
| Qrr                                       | Reverse Recovery Charge          |                                      | --         | 40         | --         | nc          |

Notes 1.The maximum current rating is package limited.

Notes 2.Repetitive Rating: Pulse width limited by maximum junction temperature

Notes 3.EAS condition: TJ=25°C

## Typical Performance Characteristics

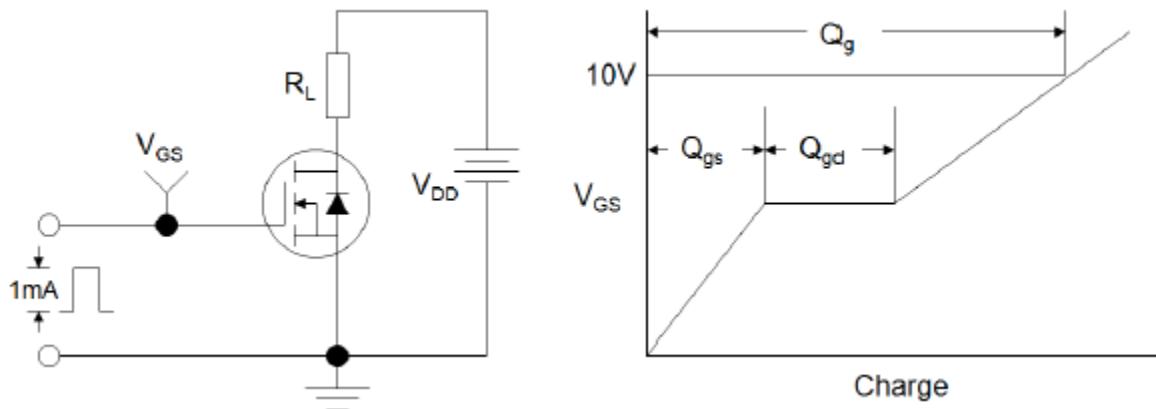


Figure 1: Gate Charge Test Circuit & Waveform

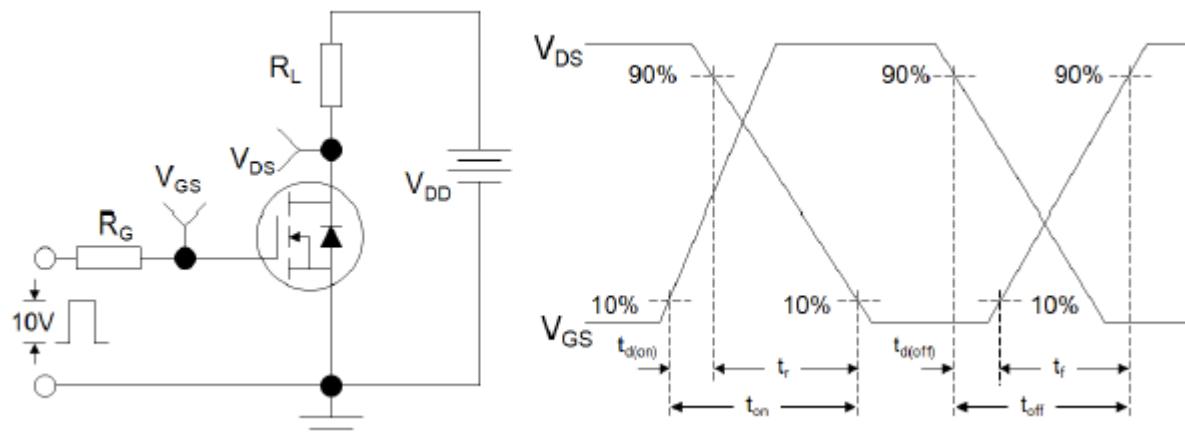


Figure 2: Resistive Switching Test Circuit & Waveforms

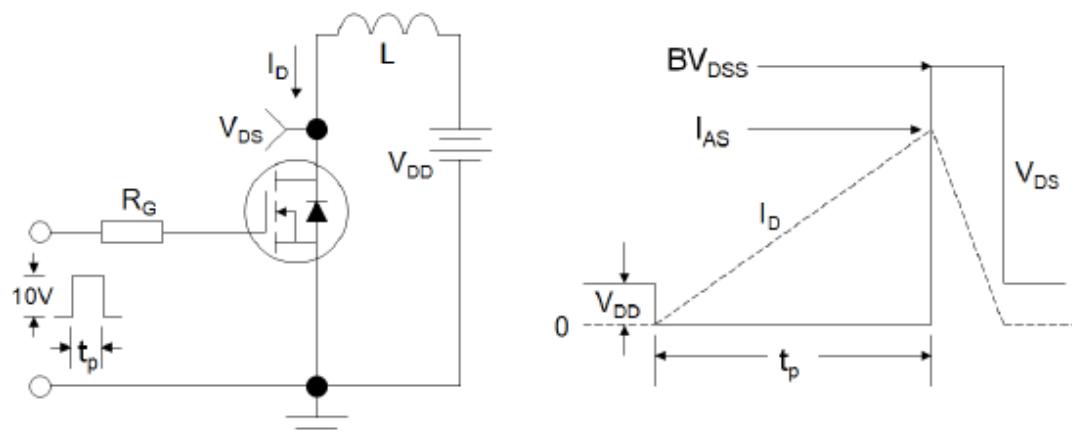
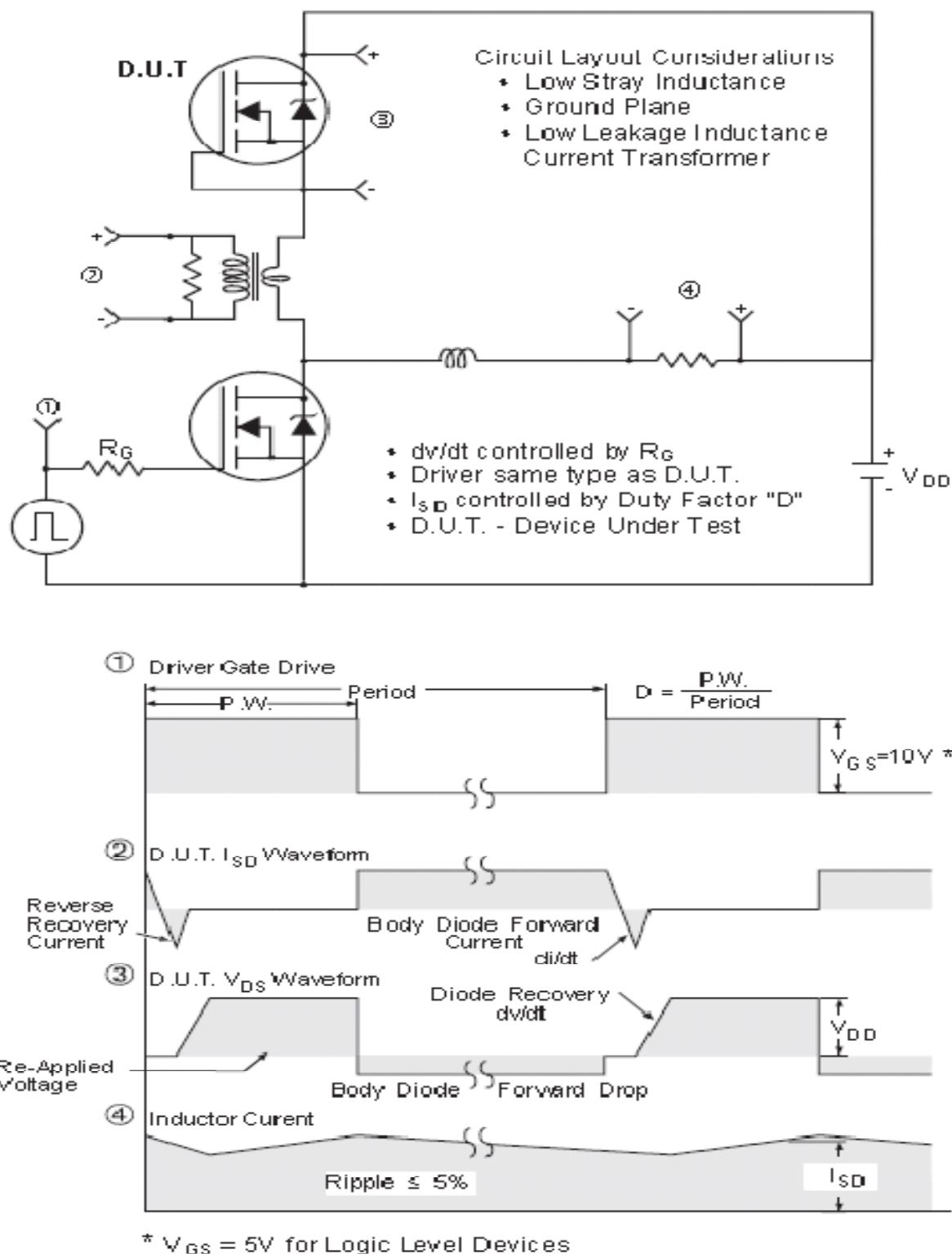
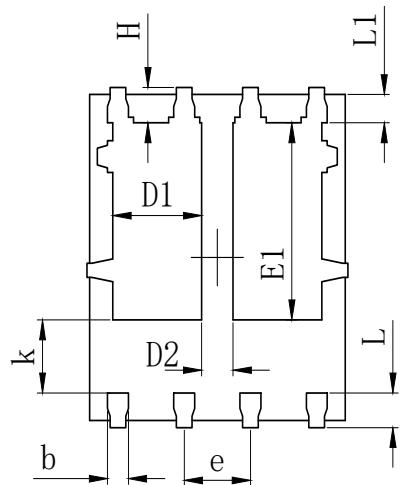
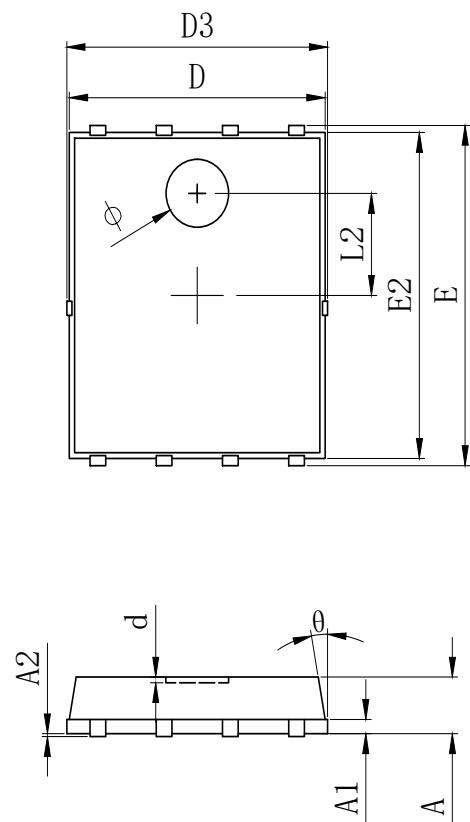


Figure 3: Unclamped Inductive Switching Test Circuit & Waveforms

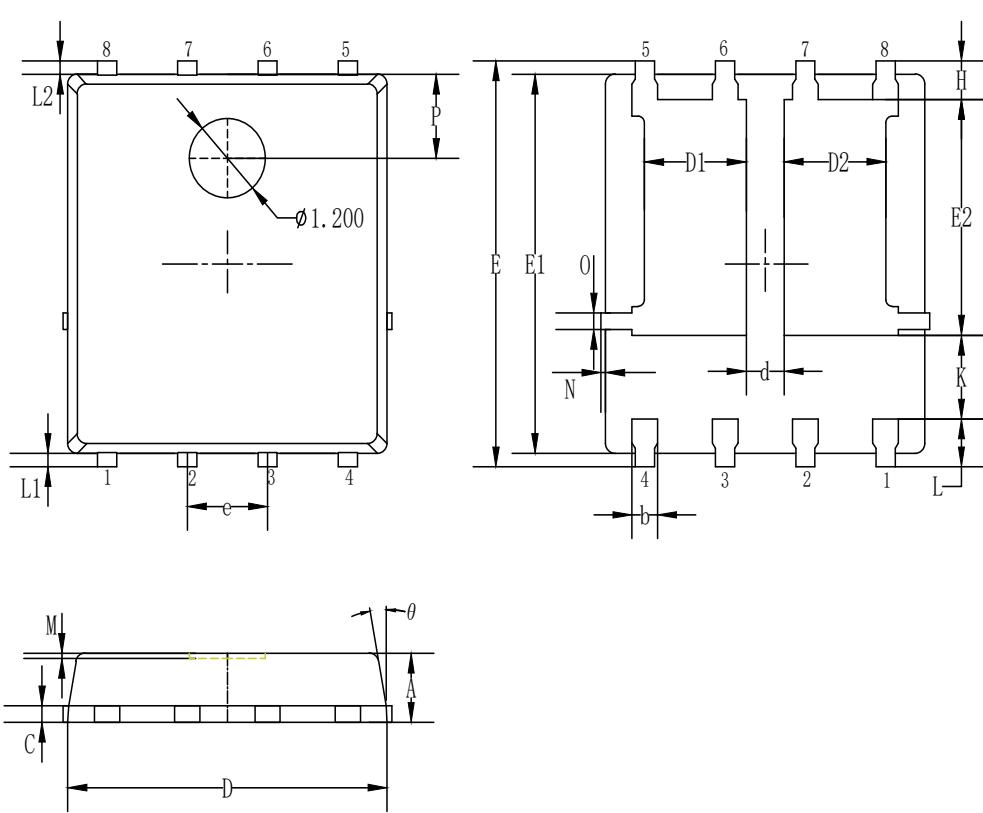


**Figure 4:Peak Diode Recovery dv/dt Test Circuit & Waveforms (For N-channel)**

•Dimensions (PDFN5\*6)



| SYMBOL   | MILLIMETER |       |       |
|----------|------------|-------|-------|
|          | MIN        | Typ.  | MAX   |
| A        | 0.900      | 1.000 | 1.100 |
| A1       | 0.254 REF. |       |       |
| A2       | 0~0.05     |       |       |
| D        | 4.824      | 4.900 | 4.976 |
| D1       | 1.605      | 1.705 | 1.805 |
| D2       | 0.500      | 0.600 | 0.700 |
| D3       | 4.924      | 5.000 | 5.076 |
| E        | 5.924      | 6.000 | 6.076 |
| E1       | 3.375      | 3.475 | 3.575 |
| E2       | 5.674      | 5.750 | 5.826 |
| b        | 0.350      | 0.400 | 0.450 |
| e        | 1.270 TYP. |       |       |
| L        | 0.534      | 0.610 | 0.686 |
| L1       | 0.424      | 0.500 | 0.576 |
| L2       | 1.800 REF. |       |       |
| k        | 1.190      | 1.290 | 1.390 |
| H        | 0.549      | 0.625 | 0.701 |
| $\theta$ | 8°         | 10°   | 12°   |
| $\phi$   | 1.100      | 1.200 | 1.300 |
| d        |            |       | 0.100 |



| Symbols  | Millimeters |      |      |
|----------|-------------|------|------|
|          | MIN.        | NOM. | MAX. |
| A        | 0.90        | 1.05 | 1.20 |
| b        | 0.35        | 0.40 | 0.50 |
| C        | 0.20        | 0.25 | 0.35 |
| D        | 4.90        | 5.05 | 5.20 |
| D1/D2    | 1.51        | 1.61 | 1.71 |
| d        | 0.50        | 0.60 | 0.70 |
| E        | 6.00        | 6.15 | 6.30 |
| E1       | 5.60        | 5.75 | 5.90 |
| E2       | 3.47        | 3.57 | 3.67 |
| e        | 1.27 BSC.   |      |      |
| H        | 0.48        | 0.58 | 0.68 |
| K        | 1.17        | 1.27 | 1.37 |
| L        | 0.64        | 0.74 | 0.84 |
| L1/L2    | 0.20 REF.   |      |      |
| $\theta$ | 8°          | 10°  | 12°  |
| M        | 0.08 REF.   |      |      |
| N        | 0           | -    | 0.15 |
| O        | 0.25 REF.   |      |      |
| P        | 1.28 REF.   |      |      |

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